Application No.: 10/816,736 Docket No.: 247322002100

AMENDMENTS

In the Claims:

1. (Currently Amended) A light-emitting apparatus package, comprising:

a ceramic substrate having an electric insulating property and a good heat conductivity;

a first concave section recessed in a thickness direction of the ceramic substrate, the first concave section providing a light exit aperture on a first surface of the ceramic substrate;

a second concave section, provided in the first concave section, and further recessed in the thickness direction of the ceramic substrate <u>such that both axes of symmetry for the first concave</u> section and the second concave section are <u>substantially coaxial</u>, the second concave section for providing an area for mounting a light-emitting device on a bottom surface of the second concave section;

a wiring pattern provided on a peripheral surface of the ceramic substrate of [[in]] at least one of the first concave section [[and]] or the second concave section, the wiring pattern for supplying extending through the ceramic substrate to electrically connect to an external connection terminal separated from the wiring pattern on the surface of the ceramic substrate, the wiring pattern being operable to supply electricity to the light-emitting device; and

a metalized layer, provided in direct contact with at least a part of the bottom surface of the second concave section in such a manner that the metalized layer is electrically insulated from the wiring pattern, the metalized layer having a light reflective property.

- 2-3. (Cancelled).
- 4. (Original) The light-emitting apparatus package as set forth in Claim 1, wherein: the metalized layer is exposed within the second concave section.
- 5. (Original) The light-emitting apparatus package as set forth in Claim 1, wherein: the ceramic substrate contains aluminum nitride.
- 6-39. (Cancelled).

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40. (Previously Presented) The light emitting apparatus package as set forth in claim 1, wherein:

the ceramic substrate has a resistance of not less than $10^{10} \, (\Omega \cdot \text{cm})$ and has a heat conductivity of not less than 18 (W/m·k).

41. (Cancelled).